

### (12) United States Design Patent (10) Patent No.: US D964,443 S Murata (45) Date of Patent: \*\* Sep. 20, 2022

(54) GAS INLET ATTACHMENT FOR WAFER PROCESSING APPARATUS

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H01L 21/02263; H01L 21/31; H01L 21/205; H01L 21/0228; H01L 21/02164 See application file for complete search history.

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  - USPC ..... D15/144.1
- (58) Field of Classification Search

USPC ...... D13/122, 182, 184, 199; D15/144, D15/144.1, 144.2; D8/2, 382

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### (57) **CLAIM**

The ornamental design for a gas inlet attachment for wafer processing apparatus, as shown and described.

CPC . C23C 16/00; C23C 16/455; C23C 16/45502; C23C 16/45504; C23C 16/45506; C23C 16/45508; C23C 16/4551; C23C 16/45512; C23C 16/45514; C23C 16/45517; C23C 16/45563; C23C 16/4557; C23C 16/45576; C23C 16/45578; C23C 16/402; C23C 16/4584; C23C 16/45587; C23C 16/45525; C23C 16/45544; C23C 16/46; C23C 16/45527; C23C 16/4412; H01L 21/00; H01L 21/02;

### DESCRIPTION

FIG. 1 is a front, top and right side perspective view of a gas inlet attachment for wafer processing apparatus showing our new design;

FIG. 2 is a front elevational view thereof;
FIG. 3 is a left side elevational view thereof;
FIG. 4 is a right side elevational view thereof;
FIG. 5 is a rear elevational view thereof;
FIG. 6 is a top plan view thereof;
FIG. 7 is a bottom plan view thereof; and, (Continued)



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## FIG. 8 is a cross sectional view taken along line 8-8 in FIG.4.

1 Claim, 6 Drawing Sheets

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# FIG. 3

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FIG. 6



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